

Part Number: L-7104RT/1G1YD

Green  
Yellow

### Features

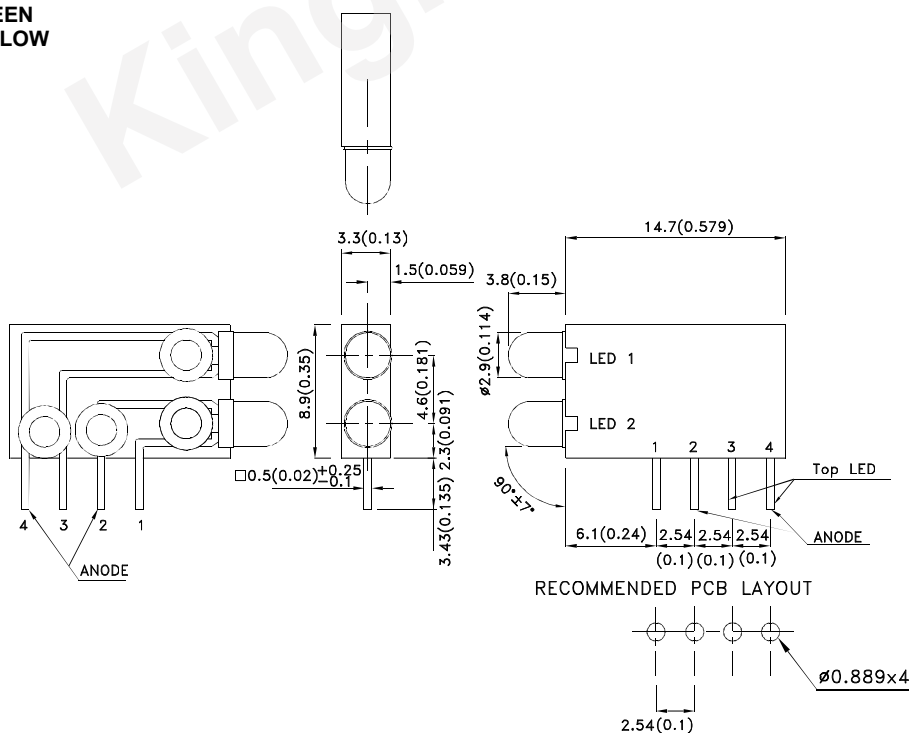
- Pre-trimmed leads for pc mounting.
- Black case enhances contrast ratio.
- Wide viewing angle.
- High reliability life measured in years.
- Housing UL rating:94V-0.
- Housing material: type 66 nylon.
- RoHS compliant.

### Descriptions

- The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.
- The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

### Package Dimensions

LED1: GREEN  
LED2: YELLOW



#### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25(0.01)$  unless otherwise noted.
3. Lead spacing is measured where the lead emerge from the package.
4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.



## Selection Guide

Part No.	Emitting Color (Material)	Lens Type	Iv (mcd) [2] @ 10mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
L-7104RT/1G1YD	Green (GaP)	Green Diffused	10	25	50°
	Yellow (GaAsP/GaP)	Yellow Diffused	8	15	50°

### Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.
3. Luminous intensity value is traceable to CIE127-2007 standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green Yellow	565 590		nm	IF=10mA
λD [1]	Dominant Wavelength	Green Yellow	568 588		nm	IF=10mA
Δλ1/2	Spectral Line Half-width	Green Yellow	30 35		nm	IF=10mA
C	Capacitance	Green Yellow	15 20		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green Yellow	2.0 1.95	2.5 2.5	V	IF=10mA
IR	Reverse Current	Green Yellow		10 10	uA	VR = 5V

### Notes:

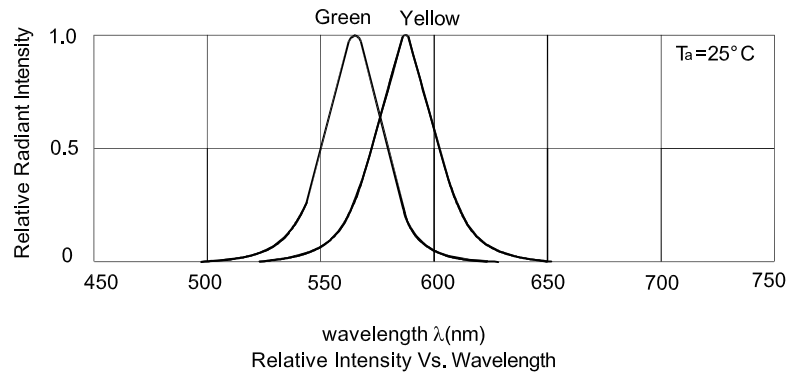
1. Wavelength: + / -1nm.
2. Forward Voltage: + / -0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

## Absolute Maximum Ratings at TA=25°C

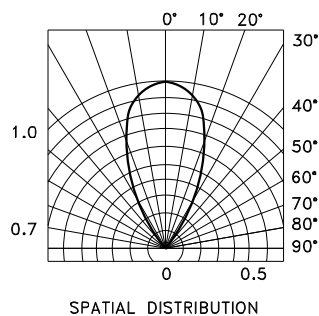
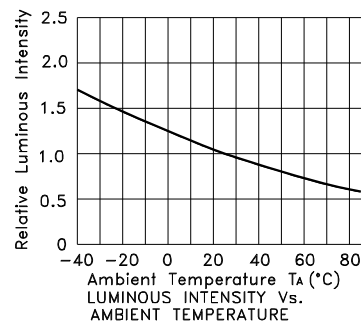
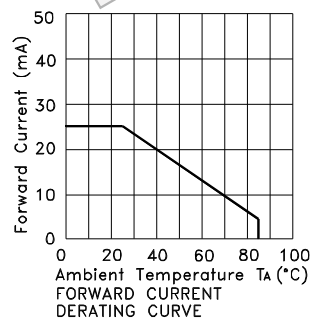
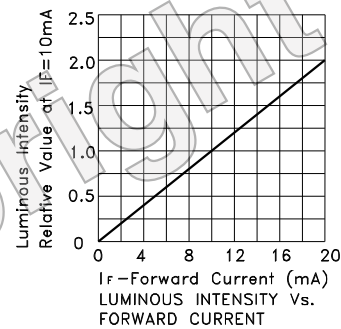
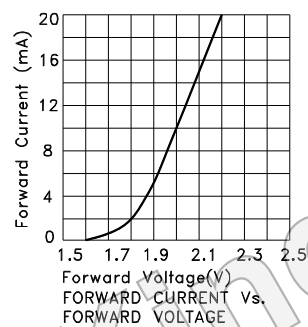
Parameter	Green	Yellow	Units
Power dissipation	62.5	75	mW
DC Forward Current	25	30	mA
Peak Forward Current [1]	140	140	mA
Reverse Voltage	5		V
Operating / Storage Temperature	-40°C To +85°C		
Lead Solder Temperature [2]	260°C For 3 Seconds		
Lead Solder Temperature [3]	260°C For 5 Seconds		

### Notes:

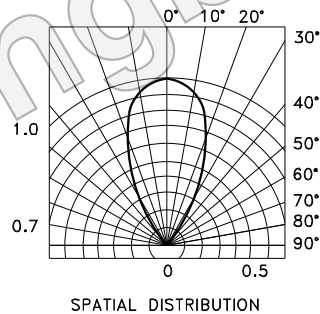
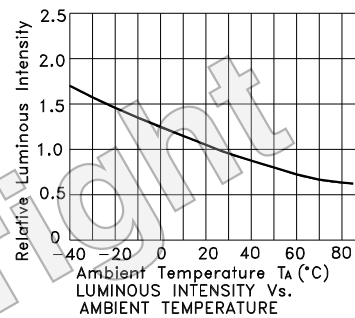
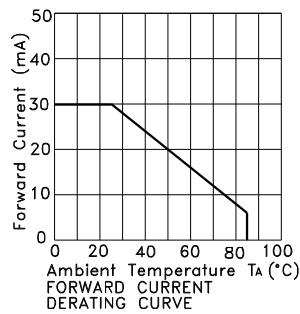
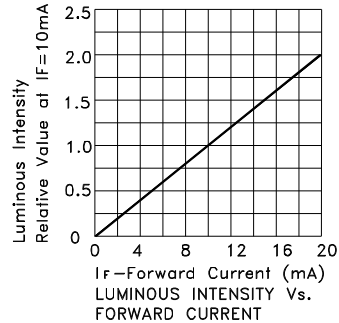
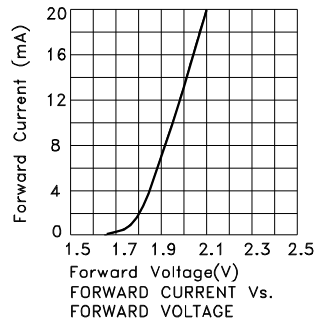
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
3. 5mm below package base.
4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



**L-7104RT/1G1YD**  
**Green**

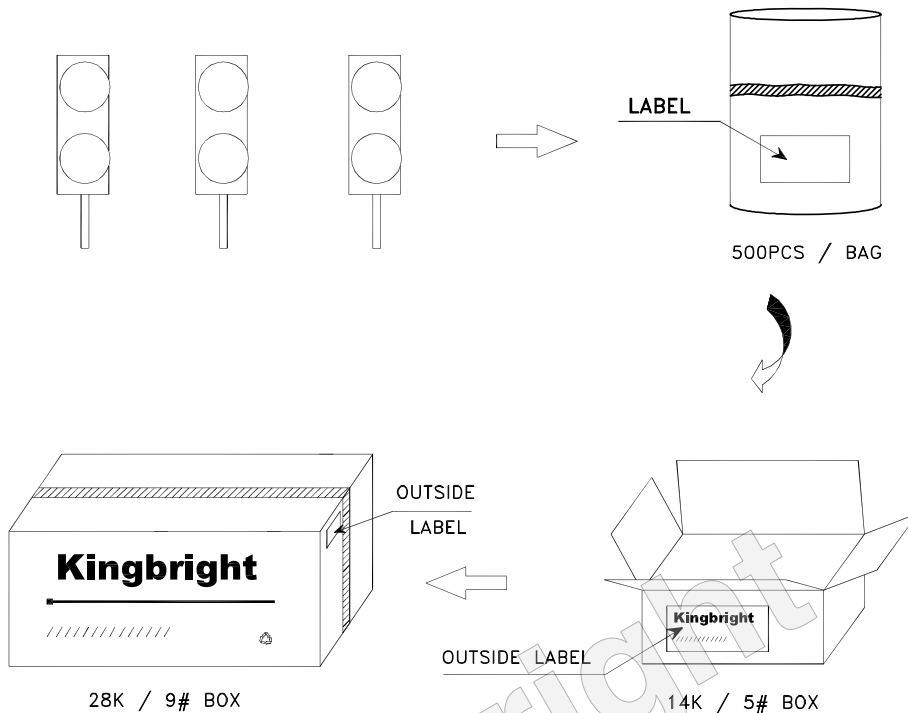


## Yellow



## PACKING & LABEL SPECIFICATIONS

L-7104RT/1G1YD



<b>Kingbright</b>		
P/N: L-7104RTxxx		
QTY: 500 pcs	Q.C.	Q C XX-XX-XXXX PASSED
S/N: XXXX		
CODE: XXX		
LOT NO:		
RoHS Compliant		

### Terms and conditions for the usage of this document

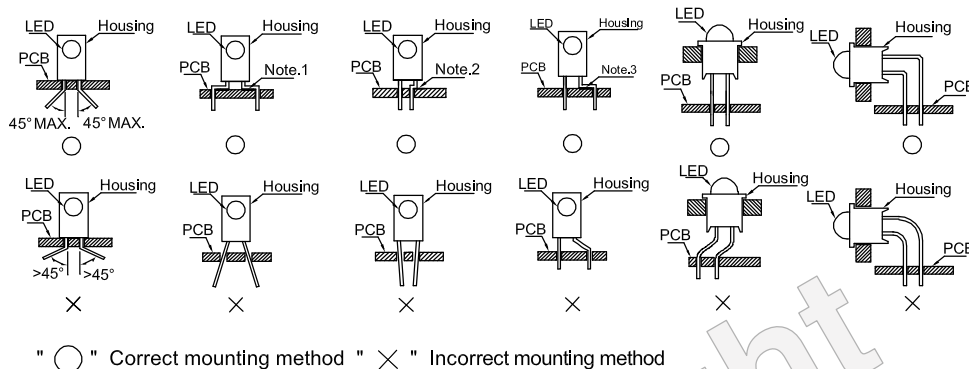
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## PRECAUTIONS

### 1. Storage conditions:

- Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
- LEDs should be stored with temperature  $\leq 30^{\circ}\text{C}$  and relative humidity  $< 60\%$ .
- Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at  $85 \sim 100^{\circ}\text{C}$ .

### 2. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.



Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

### 3. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.

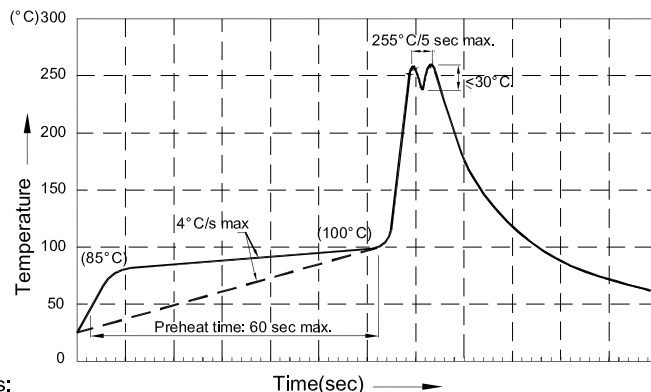


### 4. The tip of the soldering iron should never touch the lens epoxy.

### 5. Through-hole LEDs are incompatible with reflow soldering.

### 6. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.

### 7. Recommended Wave Soldering Profiles:



#### Notes:

- Recommend pre-heat temperature of  $105^{\circ}\text{C}$  or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of  $260^{\circ}\text{C}$
- Peak wave soldering temperature between  $245^{\circ}\text{C} \sim 255^{\circ}\text{C}$  for 3 sec (5 sec max).
- Do not apply stress to the epoxy resin while the temperature is above  $85^{\circ}\text{C}$ .
- Fixtures should not incur stress on the component when mounting and during soldering process.
- SAC 305 solder alloy is recommended.
- No more than one wave soldering pass.